

Vishay Siliconix

RoHS

COMPLIANT HALOGEN

FREE

N-Channel 30 V (D-S) MOSFET

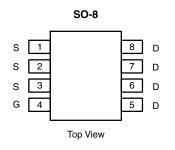
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A)	Q _g (Typ.)		
30	0.021 at V _{GS} = 10 V	12 ^a	3.7 nC		
	0.033 at V _{GS} = 4.5 V	6	3.7 110		

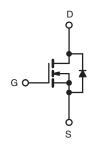
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook System Power
- Low Current DC/DC





Ordering Information: Si4128BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 25		
	T _C = 25 °C		12 ^a		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	9.7		
Continuous Drain Guirent (1) = 150 C)	T _A = 25 °C	טי	8.3 ^{b, c}		
	T _A = 70 °C		6.7 ^{b, c}	A	
Pulsed Drain Current (t = 300 µs)		I _{DM}	40	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.2		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	10		
Single Pulse Avalanche Energy	e Pulse Avalanche Energy L = 0.1 mH		5	mJ	
	T _C = 25 °C		5		
Maximum Power Dissipation	T _C = 70 °C	P _D	3.2	w	
	T _A = 25 °C	U U	2.4 ^{b, c}	VV	
	T _A = 70 °C	1 —	1.5 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	42	53	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	19	25		

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				<u> </u>		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		25		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \ \mu A$		- 6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.4		2.8	V	
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 25 V			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	20			A	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 8.4 A		0.017	0.021	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 2 \text{ A}$		0.027	0.033		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 8.4 A		22		S	
Dynamic ^b				1	1		
Input Capacitance	C _{iss}			405		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		110			
Reverse Transfer Capacitance	C _{rss}			56			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.4 \text{ A}$		7.5	12	nC	
				3.7	5.6		
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 8.4 A		1.6			
Gate-Drain Charge	Q _{gd}			1.3			
Gate Resistance	R _g	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 6.7 A, V_GEN = 4.5 V, R_g = 1 Ω		11	20		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			7	15		
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ 6.7 A, V_{GEN} = 10 V, R_{g} = 1 Ω		12	20		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs					•	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			4.2	A	
Pulse Diode Forward Current	I _{SM}				40		
Body Diode Voltage	V _{SD}	$I_{S} = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 6.7 A, dl/dt = 100 A/μs, T _J = 25 °C		8	16	nC	
Reverse Recovery Fall Time	t _a	$r_{\rm F} = 0.7$ A, $u/u_{\rm I} = 100$ A/µs, $r_{\rm J} = 25$ °C		8.5			
Reverse Recovery Rise Time				6.5		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

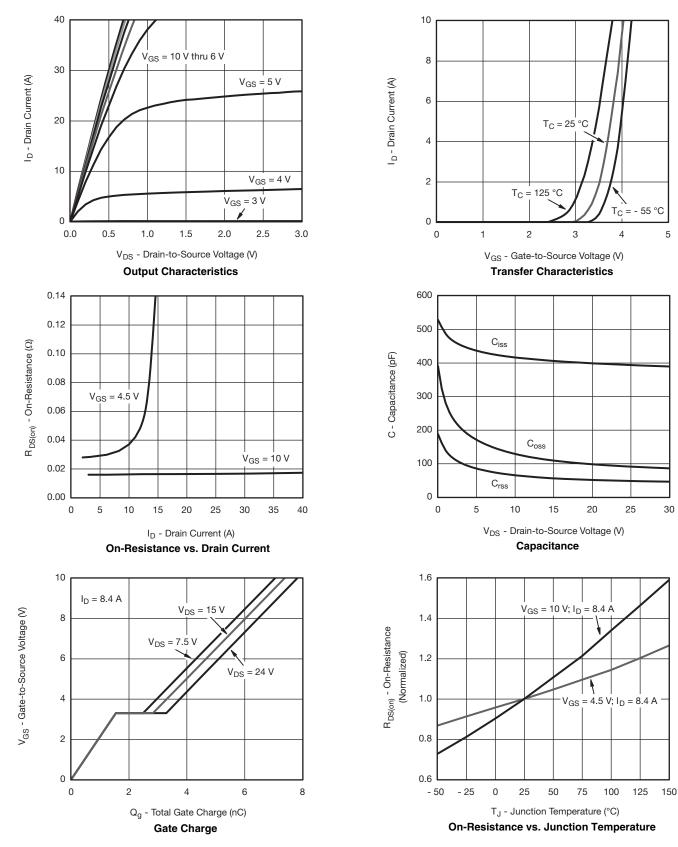
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



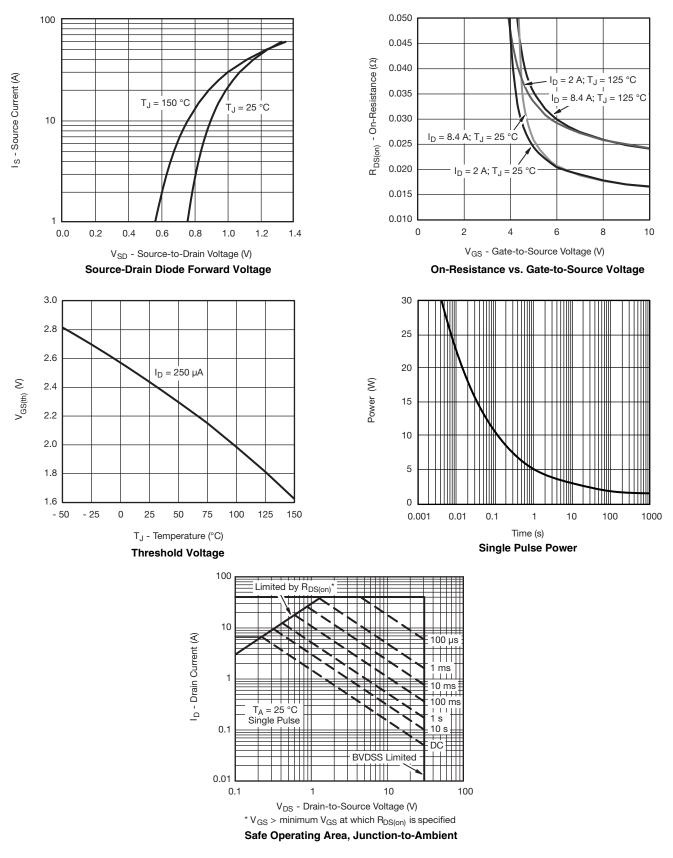
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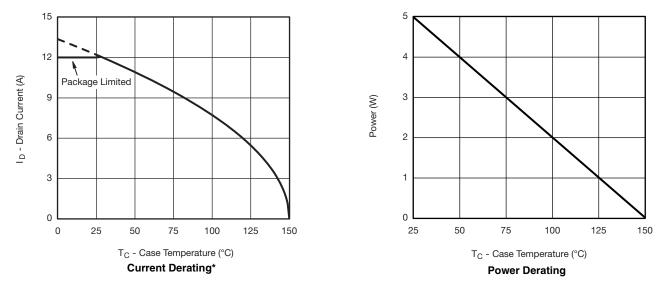


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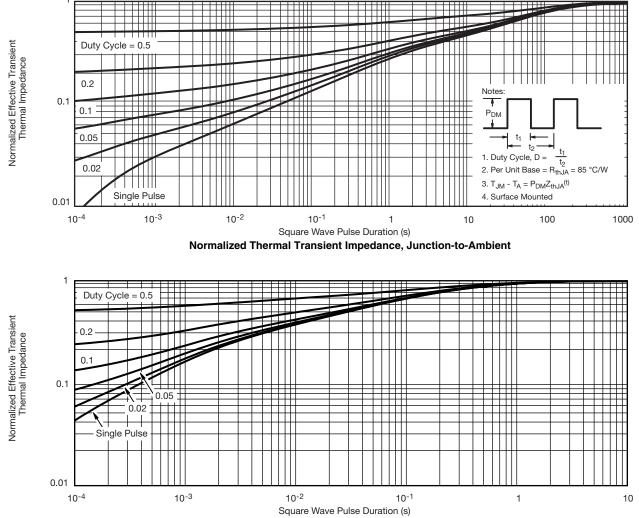


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63584.

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